

Freescale Semiconductor

 MPX2200
 Rev 13, 10/2008

200 kPa On-Chip Temperature Compensated Silicon Pressure Sensors

The MPX2200 series devices are silicon piezoresistive pressure sensor providing a highly accurate and linear voltage output directly proportional to the applied pressure. The sensor is a single monolithic silicon diaphragm with the strain gauge and a thin-film resistor network integrated on-chip. The chip is laser trimmed for precise span and offset calibration and temperature compensation. They are designed for use in applications such as pump/motor controllers, robotics, level indicators, medical diagnostics, pressure switching, barometers, altimeters, etc.

Features

- Temperature Compensated Over 0°C to +85°C
- $\pm 0.25\%$ Linearity (MPX2200D)
- Easy-to-Use Chip Carrier Package Options
- Absolute, Differential and Gauge Options

MPX2200 Series

0 to 200 kPa (0 to 29 psi)
 40 mV Full Scale Span
 (Typical)

Application Examples

- Pump/Motor Control
- Robotics
- Level Detectors
- Medical Diagnostics
- Pressure Switching
- Barometers
- Altimeters

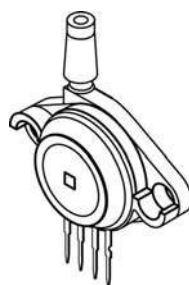
ORDERING INFORMATION

| Device Name | Package Options | Case No. | # of Ports | | | Pressure Type | | | Device Marking |
|---|-----------------|----------|------------|--------|------|---------------|--------------|----------|----------------|
| | | | None | Single | Dual | Gauge | Differential | Absolute | |
| Unibody Package (MPX2200 Series) | | | | | | | | | |
| MPX2200A | Tray | 344 | • | | | | | • | MPX2200A |
| MPX2200D | Tray | 344 | • | | | | • | | MPX2200D |
| MPX2200DP | Tray | 344C | | | • | | • | | MPX2200DP |
| MPX2200AP | Tray | 344B | | • | | | | • | MPX2200AP |
| MPX2200GP | Tray | 344B | | • | | • | | | MPX2200GP |

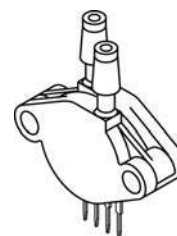
UNIBODY PACKAGES



MPX2200A/D
 CASE 344-15



MPX2200AP/GP
 CASE 344B-01



MPX2200DP
 CASE 344C-01

Operating Characteristics

Table 1. Operating Characteristics ($V_S = 10 V_{DC}$, $T_A = 25^\circ C$ unless otherwise noted, $P_1 > P_2$)

| Characteristic | Symbol | Min | Typ | Max | Units |
|--|------------------------------------|--------------------|-----------|-------------|------------------|
| Differential Pressure Range ⁽¹⁾ | P_{OP} | 0 | — | 200 | kPa |
| Supply Voltage ⁽²⁾ | V_S | — | 10 | 16 | V_{DC} |
| Supply Current | I_O | — | 6.0 | — | mA _{DC} |
| Full Scale Span ⁽³⁾ | V_{FSS} | 38.5 | 40 | 41.5 | mV |
| Offset ⁽⁴⁾ | V_{OFF} | -1.0 | — | 1.0 | mV |
| Sensitivity | $\Delta V/\Delta P$ | — | 0.2 | — | mV/kPa |
| Linearity | MPX2200D Series MPX2200A Series | — -0.25 -1.0 | — — | 0.25 1.0 | % V_{FSS} |
| Pressure Hysteresis(0 to 200 kPa) | — | — | ± 0.1 | — | % V_{FSS} |
| Temperature Hysteresis(- 40°C to +125°C) | — | — | ± 0.5 | — | % V_{FSS} |
| Temperature Coefficient of Full Scale Span | TCV_{FSS} | -1.0 | — | 1.0 | % V_{FSS} |
| Temperature Coefficient of Offset | TCV_{OFF} | -1.0 | — | 1.0 | mV |
| Input Impedance | Z_{IN} | 1300 | — | 2500 | Ω |
| Output Impedance | Z_{OUT} | 1400 | — | 3000 | Ω |
| Response Time ⁽⁵⁾ (10% to 90%) | t_R | — | 1.0 | — | ms |
| Warm-Up Time ⁽⁶⁾ | — | — | 20 | — | ms |
| Offset Stability ⁽⁷⁾ | — | — | ± 0.5 | — | % V_{FSS} |

- 1.0 kPa (kiloPascal) equals 0.145 psi.
- Device is ratiometric within this specified excitation range. Operating the device above the specified excitation range may induce additional error due to device self-heating.
- Full Scale Span (V_{FSS}) is defined as the algebraic difference between the output voltage at full rated pressure and the output voltage at the minimum rated pressure.
- Offset (V_{OFF}) is defined as the output voltage at the minimum rated pressure.
- Response Time is defined as the time for the incremental change in the output to go from 10% to 90% of its final value when subjected to a specified step change in pressure.
- Warm-up Time is defined as the time required for the product to meet the specified output voltage after the pressure is stabilized.
- Offset stability is the product's output deviation when subjected to 1000 hours of Pulsed Pressure, Temperature Cycling with Bias Test.

Maximum Ratings

Table 2. Maximum Ratings⁽¹⁾

| Rating | Max Value | Unit |
|----------------------------|-------------|------|
| Maximum Pressure (P1 > P2) | 800 | kPa |
| Storage Temperature | -40 to +125 | °C |
| Operating Temperature | -40 to +125 | °C |

1. Exposure beyond the specified limits may cause permanent damage or degradation to the device.

Voltage Output versus Applied Differential

The output voltage of the differential or gauge sensor increases with increasing pressure applied to the pressure side (P1) relative to the vacuum side (P2). Similarly, output

voltage increases as increasing vacuum is applied to the vacuum side (P2) relative to the pressure side (P1).

Figure 1 shows a block diagram of the internal circuitry on the stand-alone pressure sensor chip.

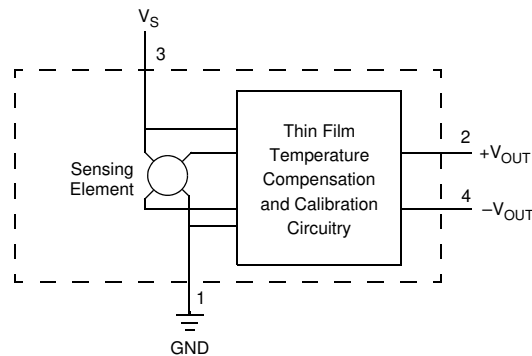


Figure 1. Temperature Compensated and Calibrated Pressure Sensor Schematic

On-Chip Temperature Compensation and Calibration

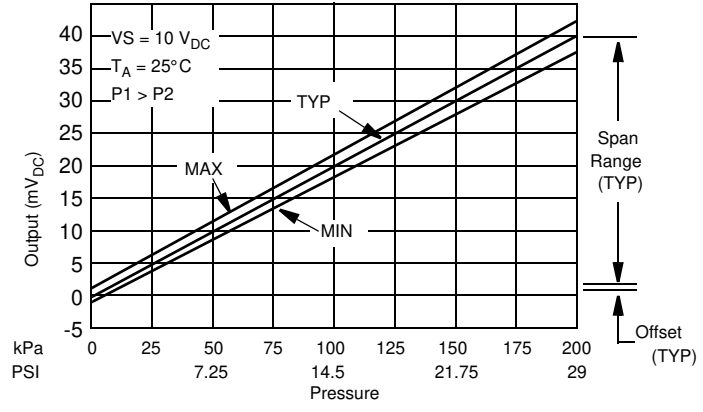


Figure 2. Output vs. Pressure Differential

Figure 2 shows the output characteristics of the MPX2200 series at 25°C. The output is directly proportional to the differential pressure and is essentially a straight line.

The effects of temperature on full scale span and offset are very small and are shown under Operating Characteristics.

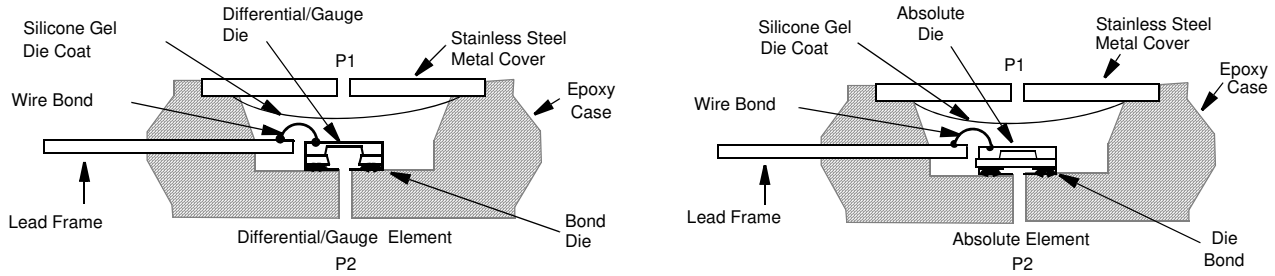


Figure 3. Cross Sectional Diagram (not to scale)

Figure 3 illustrates the differential/gauge die in the basic chip carrier (Case 344). A silicone gel isolates the die surface and wire bonds from the environment, while allowing the pressure signal to be transmitted to the silicon diaphragm.

The MPX2200 series pressure sensor operating characteristics and internal reliability and qualification tests are based on use of dry air as the pressure media. Media other than dry air may have adverse effects on sensor performance and long term reliability. Contact the factory for information regarding media compatibility in your application.

LINEARITY

Linearity refers to how well a transducer's output follows the equation: $V_{OUT} = V_{OFF} + \text{sensitivity} \times P$ over the operating pressure range. There are two basic methods for calculating nonlinearity: (1) end point straight line fit (see Figure 4) or (2) a least squares best line fit. While a least squares fit gives the "best case" linearity error (lower numerical value), the calculations required are burdensome.

Conversely, an end point fit will give the "worst case" error (often more desirable in error budget calculations) and the calculations are more straightforward for the user. Freescale's specified pressure sensor linearities are based on the end point straight line method measured at the midrange pressure.

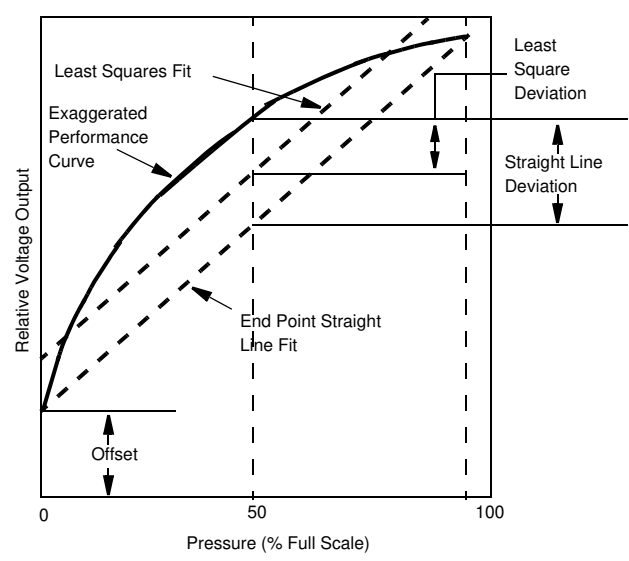


Figure 4. Linearity Specification Comparison

PRESSURE (P1)/VACUUM (P2) SIDE IDENTIFICATION TABLE

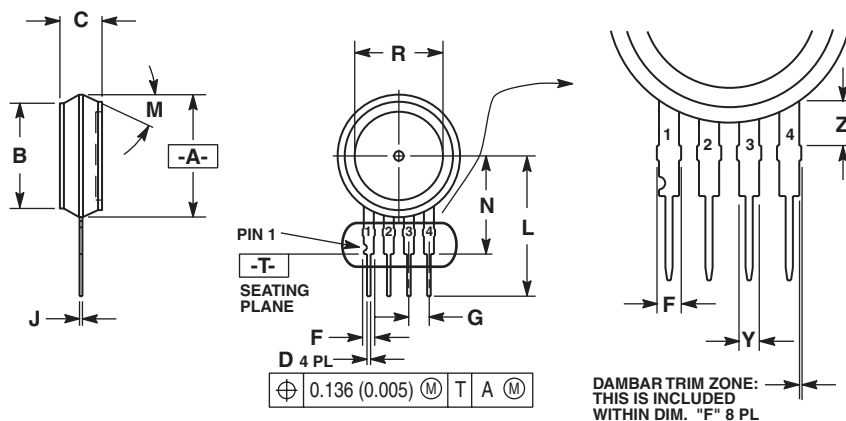
Freescale designates the two sides of the pressure sensor as the Pressure (P1) side and the Vacuum (P2) side. The Pressure (P1) side is the side containing silicone gel which isolates the die from the environment. The Freescale MPX pressure sensor is designed to operate with positive differential pressure applied, $P1 > P2$.

The Pressure (P1) side may be identified by using the following table.

Table 3. Pressure (P1) Side Delineation

| Part Number | Case Type | Pressure (P1) Side Identifier |
|--------------|-----------|-------------------------------|
| MPX2200D/A | 344 | Stainless Steel Cap |
| MPX2200DP | 344C | Side with Part Marking |
| MPX2200GP/AP | 344B | Side with Port Attached |

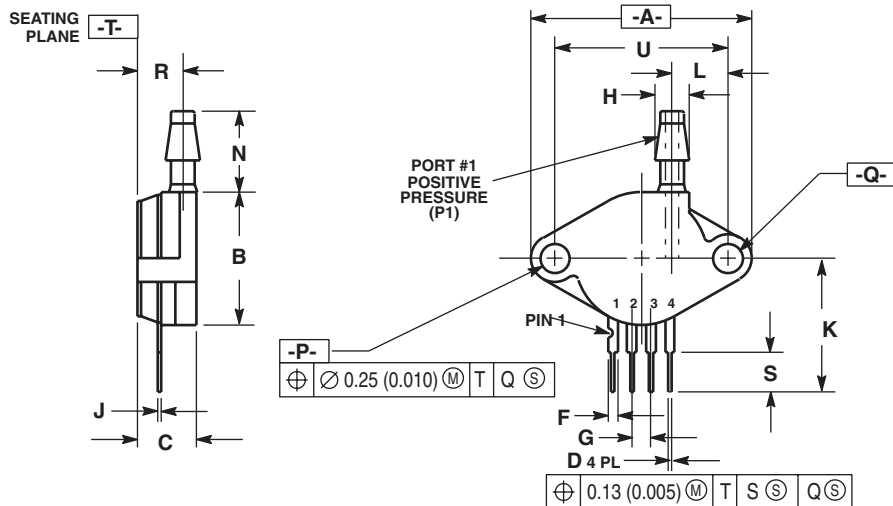
PACKAGE DIMENSIONS



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION -A- IS INCLUSIVE OF THE MOLD STOP RING. MOLD STOP RING NOT TO EXCEED 16.00 (0.630).

| DIM | INCHES | | MILLIMETERS | |
|-----|-----------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.595 | 0.630 | 15.11 | 16.00 |
| B | 0.514 | 0.534 | 13.06 | 13.56 |
| C | 0.200 | 0.220 | 5.08 | 5.59 |
| D | 0.016 | 0.020 | 0.41 | 0.51 |
| F | 0.048 | 0.064 | 1.22 | 1.63 |
| G | 0.100 BSC | | 2.54 BSC | |
| J | 0.014 | 0.016 | 0.36 | 0.40 |
| L | 0.695 | 0.725 | 17.65 | 18.42 |
| M | 30° NOM | | 30° NOM | |
| N | 0.475 | 0.495 | 12.07 | 12.57 |
| R | 0.430 | 0.450 | 10.92 | 11.43 |
| Y | 0.048 | 0.052 | 1.22 | 1.32 |
| Z | 0.106 | 0.118 | 2.68 | 3.00 |

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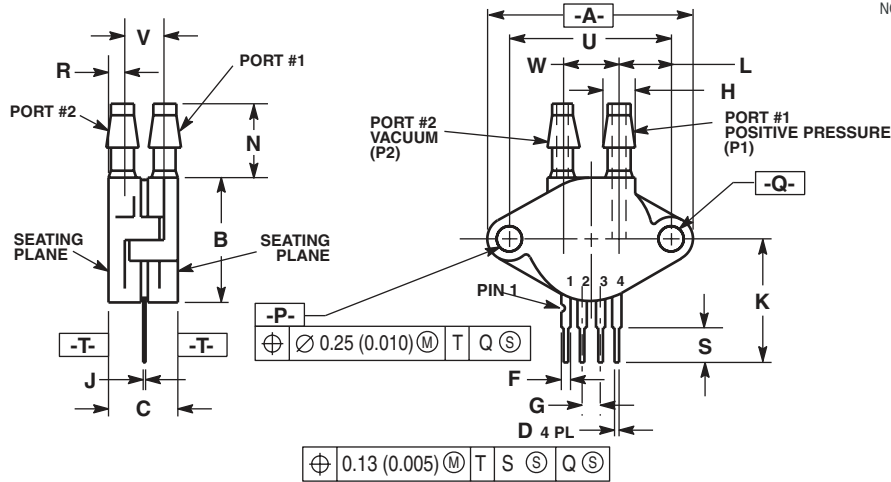


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

| DIM | INCHES | | MILLIMETERS | |
|-----|-----------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 1.145 | 1.175 | 29.08 | 29.85 |
| B | 0.685 | 0.715 | 17.40 | 18.16 |
| C | 0.305 | 0.325 | 7.75 | 8.26 |
| D | 0.016 | 0.020 | 0.41 | 0.51 |
| F | 0.048 | 0.064 | 1.22 | 1.63 |
| G | 0.100 BSC | | 2.54 BSC | |
| H | 0.182 | 0.194 | 4.62 | 4.93 |
| J | 0.014 | 0.016 | 0.36 | 0.41 |
| K | 0.695 | 0.725 | 17.65 | 18.42 |
| L | 0.290 | 0.300 | 7.37 | 7.62 |
| N | 0.420 | 0.440 | 10.67 | 11.18 |
| P | 0.153 | 0.159 | 3.89 | 4.04 |
| Q | 0.153 | 0.159 | 3.89 | 4.04 |
| R | 0.230 | 0.250 | 5.84 | 6.35 |
| S | 0.220 | 0.240 | 5.59 | 6.10 |
| U | 0.910 BSC | | 23.11 BSC | |

CASE 344B-01 ISSUE B UNIBODY PACKAGE

PACKAGE DIMENSIONS



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

| DIM | INCHES | | MILLIMETERS | |
|-----|-----------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 1.145 | 1.175 | 29.08 | 29.85 |
| B | 0.685 | 0.715 | 17.40 | 18.16 |
| C | 0.405 | 0.435 | 10.29 | 11.05 |
| D | 0.016 | 0.020 | 0.41 | 0.51 |
| F | 0.048 | 0.064 | 1.22 | 1.63 |
| G | 0.100 BSC | | 2.54 BSC | |
| H | 0.182 | 0.194 | 4.62 | 4.93 |
| J | 0.014 | 0.016 | 0.36 | 0.41 |
| K | 0.695 | 0.725 | 17.65 | 18.42 |
| L | 0.290 | 0.300 | 7.37 | 7.62 |
| N | 0.420 | 0.440 | 10.67 | 11.18 |
| P | 0.153 | 0.159 | 3.89 | 4.04 |
| Q | 0.153 | 0.159 | 3.89 | 4.04 |
| R | 0.063 | 0.083 | 1.60 | 2.11 |
| S | 0.220 | 0.240 | 5.59 | 6.10 |
| U | 0.910 BSC | | 23.11 BSC | |
| V | 0.248 | 0.278 | 6.30 | 7.06 |
| W | 0.310 | 0.330 | 7.87 | 8.38 |

**CASE 344C-01
 ISSUE B
 UNIBODY PACKAGE**

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